

ACUROS[®] CQD[®] 1920L USB3 eSWIR Camera ACUROS-1920-USB3-004

The ACUROS CQD L-Series extended SWIR (eSWIR) cameras feature large sensor area, low angular dependence and a long working distance for highly divergent emitters and collimated beams. ACUROS cameras deliver high resolution, high dynamic range and very high detectivity imaging from 400 nm to 2000 nm. The L-Series cameras are designed for use exclusively in laser beam diagnostics, laser beam imaging and laser alignment applications by mitigating interference fringing sources.

SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description	
Sensor	ACUROS CQD sensor	
Temperature Stabilization	Single-stage thermo-electric cooler	
Sensor Array Format	1920 x 1080	
Resolution	2.07 MP (megapixel)	
Spectral Band	400–2000 nm	
Array Size	28.8 mm x 16.2 mm, 33 mm diagonal	
Pixel Pitch	15 μm x 15 μm	
Max Frame Rate at Full Resolution	58 fps (8, 10, 12, 14 bit)	
Pixel Operability	99.9% typical, 99.75% min	
Bit Depth	8, 10, 12, 14 bit selectable	
Integration Type	Snapshot global shutter	
Trigger	External TTL	
Integration Time	100 μs to 4 s	
Dynamic Range	65 dB typical	
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size	
Laser Beam Fringeless Operation	Yes	
Binning Arrays	2 x 2, 4 x 4	
Non-uniformity Correction	2-point non-uniformity correction	
Temporal Dark Noise	80/70/65 e-typical (high gain)	
Quantum Efficiency	See typical QE curve (Figure 4)	



ORDERING INFORMATION

Part Number	
ACUROS-1920-USB3-004	

Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- 2.1 MP Resolution
- Linear Photoresponse
- TEC Cooling
- Low Noise
- USB3 Vision
- Visible-eSWIR

Applications

- Laser beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

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Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	−20 °C to +55 °C
Power Consumption	6.5–12 W depending on TEC settings
Power Supply Voltage	6–16 V dc
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 9.1 cm (C-mount)
Weight Excluding Lens	495 grams with (C-mount) adapter
Lens Mounts	Standard mount (C-mount). Inquire for other options.
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

Parameter	Value/Description
Software Development Kit	Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS)
GenICam Compliance	Yes
Interface	USB3 Vision

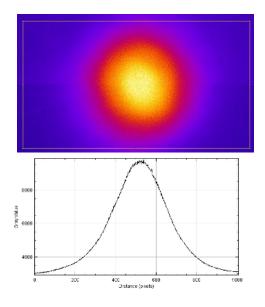


Figure 1. F-mount and M-42 Lens Mounts



Figure 2. USB Vision Interface

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1550 nm Laser image and corresponding line file (false color added post image)

Figure 3. ACUROS CQD SWIR Camera Image of Laser

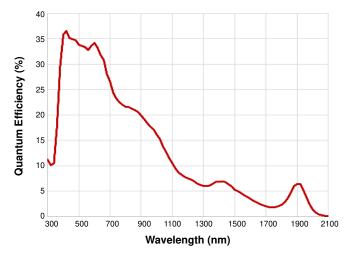


Figure 4. Typical QE Performance

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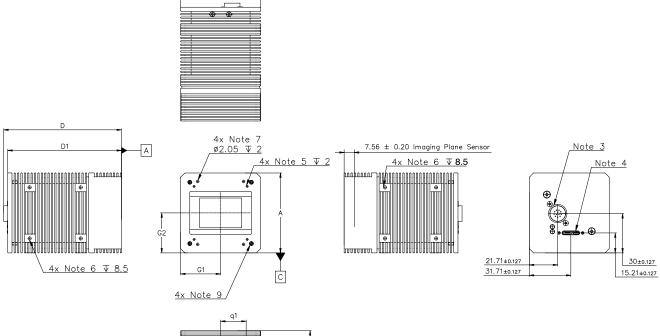


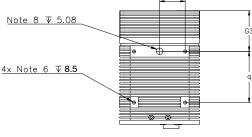
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DATE 04 OCT 2024





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 2018. 2. CONTROLLING DIMENSION: MILLIMETER
- 3. HIROSE 12 PIN CONNECTOR
- 4. USB 3.0 Micro-B
- M2x0.4 $\sqrt{2}$ M3X0.5 DEPTH $\sqrt{8.5}$
- REGISTRATION HOLES Ø2.05
- 1/4-20 UNC DEPTH ▼ 5.08
- м́2Х6

MILLIMETERS			
DIM	MIN.	NOM.	NOM.
D	89.75	89.95	90.15
D1	86.62	86.82	87.02
Е	59.03	61.00	61.13
Α	59.03	61.00	61.13
G1	30.37	30.50	30.63
G2	30.37	30.50	30.63
G3	30.84	31.04	31.24
q	38.98	39.11	39.24
q1	19.37	19.50	19.63

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